

# **Approval Sheet**

### **Customer Information**

Customer		
Part Name		
Part No.		
Model No.		
Company	Purchase	R&D

### **Vendor Information**

Name	SFI Electronics Technology Inc.
Part Name	Chip TVS
Part No.	SFI1210ML330C-LF
Lot No.	

SFI Electronics Technology Inc.					
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Quality Control         Document Control         Business Issue					
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Part No.	SFI121	OML330C-LF	Docum	ent No.	AS-RD121	OMC119-LF	REV.	К
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SMD Transient Voltage Suppressors

### PART NO. SFI1210ML330C-LF

1.1 Technology Data	Symbol		Value	Unit
Maximum allowable continuous AC voltage at 50-60Hz	V <sub>RMS</sub>		20	V
Maximum allowable continuous DC voltage	V <sub>DC</sub>		26	V
Varistor breakdown voltage	Vv		33(29.7~36.3)	V
Maximum allowable clamping voltage	V <sub>C</sub>		54	V
Maximum peak current	I <sub>Peak</sub>		250	А
1.2 Reference Data				
Maximum energy absorption	Е		1.2	J
Typical capacitance value measured at 1KHz	С		610	pF
Response time	T <sub>rise</sub>	<	1	ns
Leakage current at Vv × 80% (at initial state)	$I_{VV}$	<	50	μA
Leakage current at Vv × 80% (after surge test)	I <sub>VVA</sub>	<	200	μA
Operation ambient temperature	T <sub>OPT</sub>		-50~+85	°C
Storage temperature range	T <sub>STG</sub>		-50~+150	°C
1.3 Other Data				
Body			ZnO	
End termination			Ag/Ni/Sn	
Packaging			Reel	
Complies with standard			IEC61000-4-5	
Complies with RoHs standard			Yes	
Lead content		<	1000	ppm
Marking			None	

Notes :

 $\star$  1 The varistor breakdown voltage was measured at 1mA.

\*2 The clamping voltage was measured at 8/20µs standard current, 1210(2.5A).

 $\pm\,3$  The peak current was tested at 8/20 $\mu s$  waveform.

\*4 The capacitance and energy values only for customer reference, it's not formal specification.

 $\pm\,5$  The components shall be employed within 1 year, in the nitrogen condition.

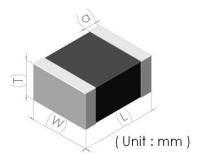
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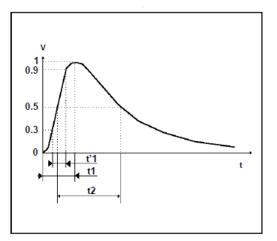
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#### 2. Size

Model	1210(3225)
Length(L)	3.20±0.20
Width(W)	2.50±0.20
Thickness(T)	1.50 max.
Termination(a)	0.50±0.20



### 3. Surge Wave Form



### IEC61000-4-5 Standards

SEVERITY LEVEL	t1 (=1.67t'1)	t2
1	8µs	20µs
2	10µs	1000µs

8/20µs waveform current

### 4. Environment Reliability Test

Characteristic	Test Method and Description					
High Temperature Storage	The specimen shall be subjected to $125\pm2^{\circ}$ for $1000\pm2$ hours without load and then stored at room temperature and normal humidity for one or two hours. The change of varistor voltage shall be within 10%.					
	The temperature cycle of specified	Step	Temperature	Period		
	temperature shall be repeated five times and	1	-40±3℃	30±3min		
Temperature Cycle	then stored at room temperature and normal humidity for one or two hours. The change of	2	room temperature	1 hour		
	varistor voltage shall be within 10% and	3	125 <b>±</b> 3℃	30±3min		
	mechanical damage shall be examined.	4	room temperature	1 hour		
High Temperature Load	After being continuously applied the maximum allowable voltage at $85\pm2^{\circ}$ C for 1000±2 hours, the specimen shall be stored at room temperature and normal humidity for one or two hours. The change of varistor voltage shall be within 10%.					
Damp Heat Load/ Humidity Load	The specimen should be subjected to $40\pm2^{\circ}$ C and $90\sim95^{\circ}$ RH, the maximum allowable voltage applied for $1000\pm2$ hours and then stored at room temperature and normal humidity for one or two hours. The change of varistor voltage shall be within 10%.					
Low Temperature Storage	The specimen should be subjected to -40±2°C then stored at room temperature and normal h change of varistor voltage shall be within 10%	numidit				

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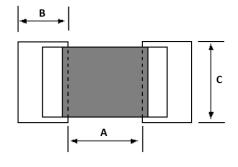


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### **5. Soldering Recommendations**

5.1 Recommended solder pad layout

			(Unit : mm)
	А	В	С
1210	1.8~2.5	1.3~2.0	2.3~3.0

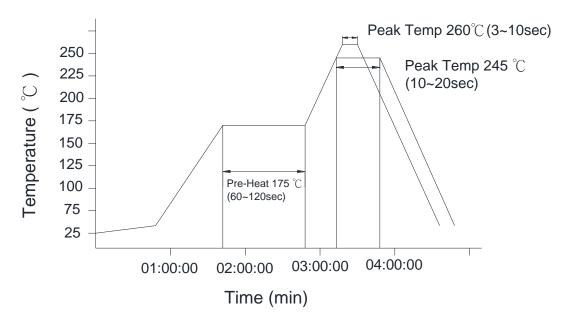


5.2 The SIR test of the solder paste shall be done (Based on JIS-Z-3284)

5.3 Steel plate and foot distance printing

Foot distance printing (mm)	Steel plate thickness (mm)
≧0.65mm	0.18mm
0.50~0.65mm	0.15mm
0.40~0.50mm	0.12mm
≦0.40mm	0.10mm

5.4 The IR reflow and temperature of soldering for Pb free process



#### $\precsim$ IR reflow Pb free process suggestion profile

- (1) The solder recommend is Sn96.5/Ag3.5 and thickness recommend as shown in table 5.3
- (2) Ramp-up rate (217°C to peak) +3°C/second max.
- (3) Temp. maintain at  $175\pm25^{\circ}$ C 180 seconds max.
- (4) Temp. maintain above  $217^{\circ}$ C 60~150 seconds

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- (5) Peak temperature range <u>245 +20/-10°C</u> within 5°C of actually peak temperature (t<sub>p</sub>) 10~20 seconds
- (6) Ramp down rate  $-6^{\circ}$ C/second max.

\* Perform adequate test in advance as the reflow temperature profile will vary according to the conditions of the manufacturing process and the specification of the reflow furnace.

5.5 Resistance to soldering heat and high temperature resistance : 260  $^\circ\!C$  , 10sec 3 times

#### 5.6 Hand soldering

In hand soldering of the varistors, large temperature gradient between preheated the varistors and the tip of soldering iron may cause electrical failures and mechanical damages such as cracking or breaking of the devices. The soldering shall be carefully controlled and carried out, so that the temperature gradient is kept minimum with following recommended conditions for hand soldering. 5.6.1 Recommended soldering condition 1 (with preheating)

(1) Solder

**0.12~0.18mm** thread solder (Sn96.5:Ag3.5) with soldering flux in the core rosin-based and non-activated flux is recommended.

(2) Preheating

The varistors shall be preheated so that temperature gradient between the devices and the tip of soldering iron is  $150^{\circ}$ C or below.

(3) Soldering iron

Rated power of 20W max. with 3mm soldering tip in diameter

Temperature of soldering iron tip  $380^{\circ}$ C max., 3~5sec (The required amount of solder shall be melted in advance on the soldering tip.)

(4) Cooling

After soldering, the varistors shall be cooled gradually at room ambient temperature.

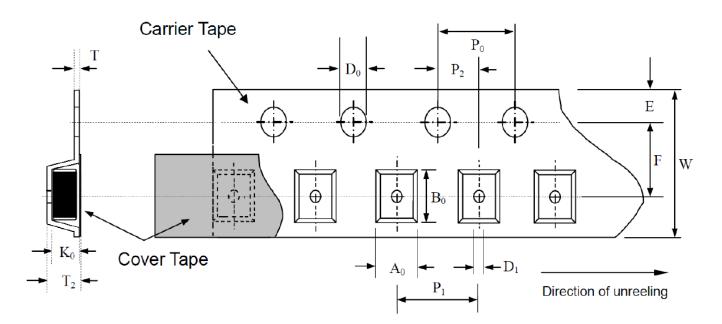
- 5.6.2 Recommended soldering condition 2 (without preheating)
  - (1) Solder iron tip shall not directly touch to ceramic dielectrics.
  - (2) Solder iron tip shall be fully preheated before soldering while soldering iron tip to the external electrode of varistors.
- 5.7 Post soldering cleaning
  - 5.7.1 Residues of corrosive soldering fluxes on the PC board after cleaning may greatly have influences on the electrical characteristic and the reliability (such as humidity resistance) of the varistors which have been mounted on the board. It shall be confirmed that the characteristic and the reliability of the devices are not affected by the applied cleaning conditions.
  - 5.7.2 When an ultrasonic cleaning is applied to the mounted variators on PC boards. Following conditions are recommended for preventing failures or damages of the devices due to the large vibration energy and the resonance conditions caused by the ultrasonic waves.
    (1) Frequency 29MHz max.
    - (2) Radiated power 20W/liter max.
    - (3) Period 5 minutes max.

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### 6. Packaging Specification

- 6.1 Carrier tape and transparent cover tape should be heat-sealed to carry the products, and the reel should be used to reel the carrier tape.
- 6.2 The adhesion of the heat-sealed cover tape shall be 40 +20/-15 grams.
- 6.3 Both the head and the end portion of the taping shall be empty for reel package and SMT auto-pickup machine. And a normal paper tape shall be connected in the head of taping for the operator to handle.



#### (Unit : mm)

Symbol	A <sub>0</sub> ±0.10	B₀ ±0.10	K₀ ±0.10	T ±0.05	T <sub>2</sub> ±0.05	D <sub>0</sub> +0.10 -0.00	D <sub>1</sub> ±0.05	P <sub>1</sub> ±0.10	P <sub>2</sub> ±0.05	P <sub>0</sub> ±0.05	W ±0.20	E ±0.10	F ±0.05
1210	2.78	3.46	1.55	0.22	1.77	1.50	1.00	4.00	2.00	4.00	8.00	1.75	3.50

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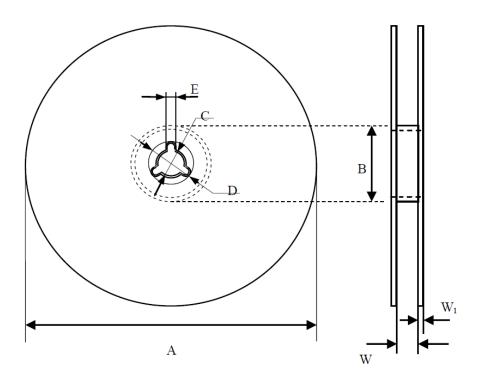
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### 7. Reel Dimension



(Unit : mm)

Symbol	Α	В	C D		Е	W	W <sub>1</sub>	
1210	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.5	1.5±0.1	

### 8. Standard Packaging

Size	1210
Pcs	2000

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